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Dear Partner,

We look forward to welcoming you to Munich, this lively and beautiful city, which will be the host of the International Conference on Cyborg and Bionic Systems, September 18-20, 2019. We aspire to attract a select audience of experts and create an enjoyable, memorable conference.

We are pleased and proud to invite you to partner with us in participating in this important conference. By selecting one of the sponsor packages from below, you will be making a step towards connecting with a very select group of academic and industry experts.

The following provides an overview of the key components of the packages being offered.

Looking forward to a mutually beneficial cooperation and a very successful conference!

Prof. Dr.-Ing. habil. Alois Christian Knoll
Technical University Munich
Informatics 6 - Chair of Robotics, Artificial Intelligence and Real-time Systems
Welcome to the 2019 IEEE International Conference on Cyborg and Bionic Systems.

The main purpose of this conference is to discuss frontier research and realistic applications on cyborg- and bionic systems, which are concerned with hybrid fusion techniques for organic and biomechatronic body parts. Of central interest is the integration of artifacts and technologies like biomorphic actuators and sensors into an effective biocybernetic system.

CBS 2019 is sponsored by the IEEE-RAS TC on Cyborgs and Bionic Systems. One of the primary goals is to make an organism restored or enhanced beyond its original biological characteristics. With the rapid development of bionic technologies, biomorphic chips and nanotechnology, we think that cyborgs and bionic systems can assist humans to conquer many limitations such as disease, disabilities, speed, strength, dexterity as well as intelligence.

TOPICS OF INTEREST

- Micro/nano biomorphic robotics
- Building brains for robots and cognitive skills
- Bio-cell assembly and tissue fabrication
- Micro bio sensor and actuator fabrication
- Prosthesis and exoskeleton robotics
- Biomorphic computation and chips
- Neuromorphic controls and communication
- Advanced materials neuromorphic sensors
- Rehabilitation robotics
- Cyborg intelligence
- Generative learning
- Cyber-physical bio-system
- Biomimetic robotics
- Perception and Cognition
- Learning
- Translation and mapping of biologic brain principles to cyborg control structures
- Neurorobotics
- Wearable robotics
- Medical surgical robotics
- Regenerative medicine
- Neural-machine interfaces
- Adaptive controls
- Artificial brains
- Biosignal processing
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## SPONSORSHIP OPPORTUNITIES

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<th>PLATINUM</th>
<th>GOLD</th>
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<td>Identified as sponsor or exhibitor on Conference Digest, and the electronic conference proceedings (incl. logo on welcome signal module)</td>
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<td>Sponsor provided promotional video for viewing in general session room before Keynotes (max 10 sec.)</td>
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<td>Rollup of your company in a visible place at the conference venue</td>
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APPLICATION

If you need any additional information on Sponsorship of the CBS 2019 please contact us!
email: info@cbs2019.com
subject: Sponsorship interest